

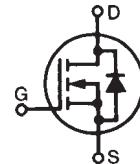
# HiPerFET™ Power MOSFETs

Electrically Isolated Tab  
N-Channel Enhancement Mode  
Avalanche Rated, Low  $Q_g$   
Low  $R_g$ , High dv/dt, Low  $t_{rr}$

## IXFR14N100Q2

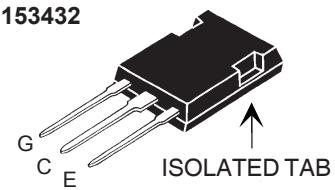
$V_{DSS}$  = 1000 V  
 $I_{D25}$  = 9.5 A  
 $R_{DS(on)}$  = 1.0  $\Omega$

$t_{rr} \leq 300$  ns



Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	1000		V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1\text{ M}\Omega$	1000		V
$V_{GS}$	Continuous	$\pm 30$		V
$V_{GSM}$	Transient	$\pm 40$		V
$I_{D25}$	$T_c = 25^\circ\text{C}$	9.5		A
$I_{DM}$	$T_c = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	56		A
$I_{AR}$	$T_c = 25^\circ\text{C}$	14		A
$E_{AR}$	$T_c = 25^\circ\text{C}$	50		mJ
$E_{AS}$	$T_c = 25^\circ\text{C}$	2.5		J
$dv/dt$	$I_s \leq I_{DM}$ , $di/dt \leq 100\text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_G = 2\Omega$	20		V/ns
$P_D$	$T_c = 25^\circ\text{C}$	200		W
$T_J$		-55 ... +150		$^\circ\text{C}$
$T_{JM}$		150		$^\circ\text{C}$
$T_{stg}$		-55 ... +150		$^\circ\text{C}$
$T_L$	1.6 mm (0.063 in) from case for 10 s	300		$^\circ\text{C}$
$V_{ISOL}$	50/60 Hz, RMS, $t = 1\text{ min}$ $I_{SOL} = 1\text{ mA}$ , $t = 1\text{ s}$	2500 3000		V~
$F_c$	Mounting Force	20..120 / 4.6..27		N/lb
Weight		5		g

### ISOPLUS247 (IXFR) E153432



G = Gate  
E = Source

C = Drain

### Features

- Double metal process for low gate resistance
- Epoxy meet UL 94 V-0, flammability classification
- Low  $R_{DS(on)}$ , low  $Q_g$
- Avalanche energy and current rated
- Fast intrinsic rectifier

### Applications

- DC-DC converters
- Switched-mode and resonant-mode power supplies, >500kHz switching
- DC choppers
- Pulse generation
- Laser drivers

### Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values		
		( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	min.	typ.
$V_{DSS}$	$V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$	1000		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4\text{ mA}$	3.0		V
$I_{GSS}$	$V_{GS} = \pm 30\text{ V}_{DC}$ , $V_{DS} = 0$		$\pm 200$	nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{ V}$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	25 1	$\mu\text{A}$ mA
$R_{DS(on)}$	$V_{GS} = 10\text{ V}$ , $I_D = I_T$ Pulse test, $t \leq 300\text{ }\mu\text{s}$ , duty cycle $d \leq 2\%$		0.90	$\Omega$

Symbol	Test Conditions	Characteristic Values		
		min.	typ.	max.
$g_{fs}$	$V_{DS} = 10 \text{ V}; I_D = I_T$ , pulse test	10	14	S
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	2700	pF	
		300	pF	
		100	pF	
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_b = I_T$ $R_G = 2 \Omega$ (External),	12	ns	
		10	ns	
		28	ns	
		12	ns	
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = I_T$	83	nC	
		20	nC	
		40	nC	
$R_{thJC}$		0.62	K/W	
$R_{thCK}$		0.25	K/W	

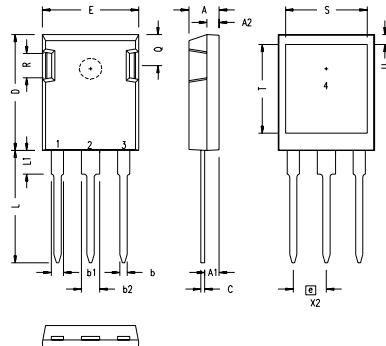
Note: Test current  $I_T = 7\text{A}$

#### Source-Drain Diode

Characteristic Values  
( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

Symbol	Test Conditions	min.	typ.	max.
$I_s$	$V_{GS} = 0 \text{ V}$		14	A
$I_{SM}$	Repetitive; pulse width limited by $T_{JM}$		56	A
$V_{SD}$	$I_F = I_S, V_{GS} = 0 \text{ V}$ , Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2\%$		1.5	V
$t_{rr}$ $Q_{RM}$ $I_{RM}$	$I_F = I_S, -di/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$	0.8 0.7	300 $\mu\text{C}$ A	ns

#### ISOPLUS247 Outline

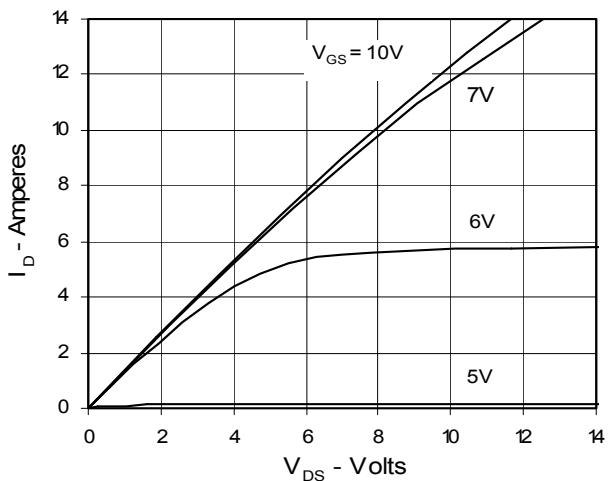


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.084	1.91	2.13
b2	.115	.123	2.92	3.12
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215 BSC		5.45 BSC	
L	.780	.800	19.81	20.32
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03

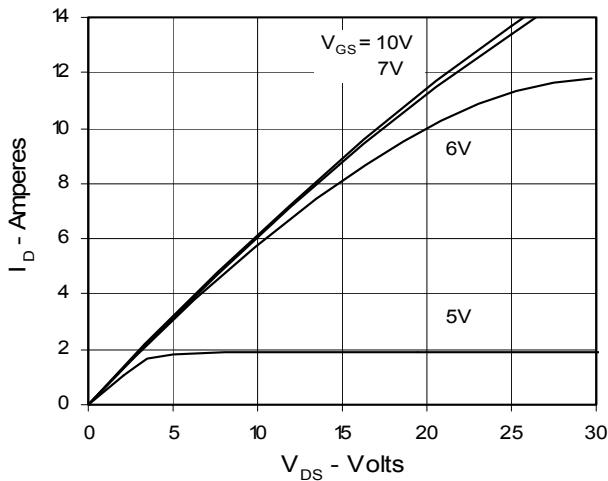
- 1 – GATE  
2 – DRAIN (COLLECTOR)  
3 – SOURCE (EMITTER)  
4 – NO CONNECTION

NOTE: This drawing will meet all dimensions requirement of JEDEC outline TO-247AD except screw hole.

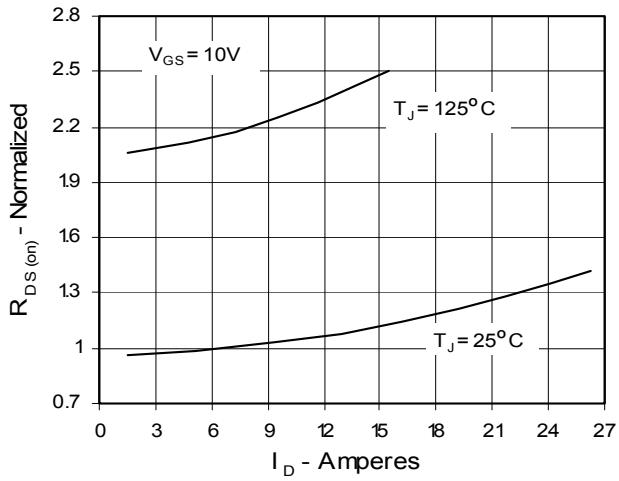
**Fig. 1. Output Characteristics  
@ 25 Deg. C**



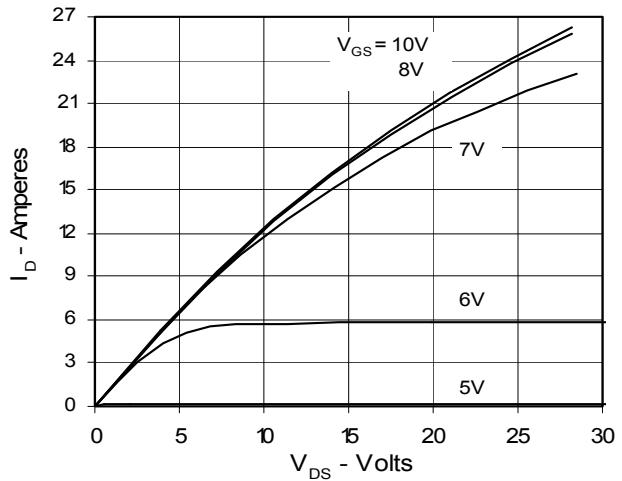
**Fig. 3. Output Characteristics  
@ 125 Deg. C**



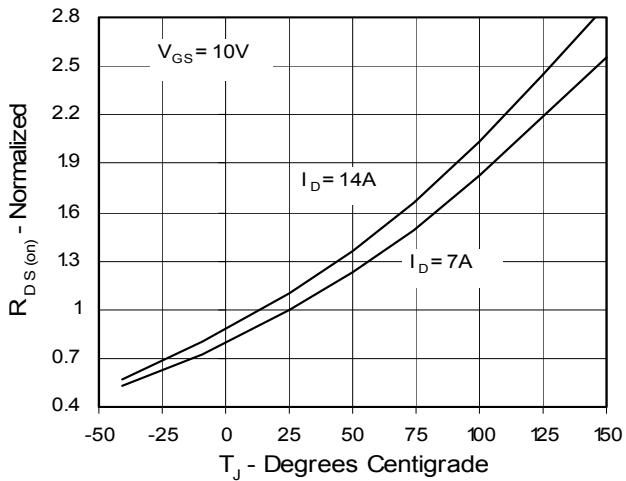
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_{D25}$  Value vs.  $I_D$**



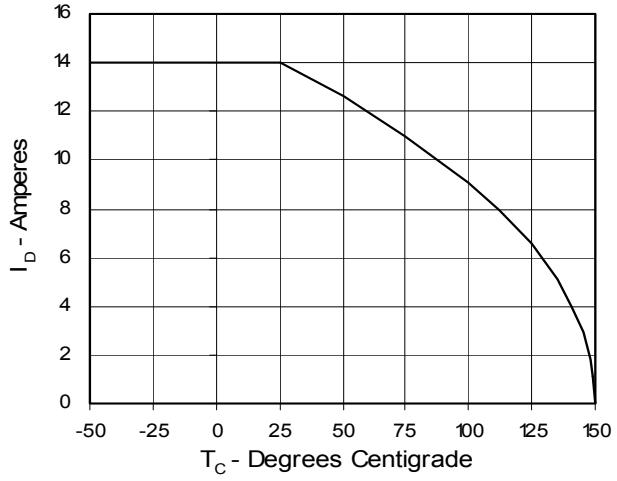
**Fig. 2. Extended Output Characteristics  
@ 25 deg. C**

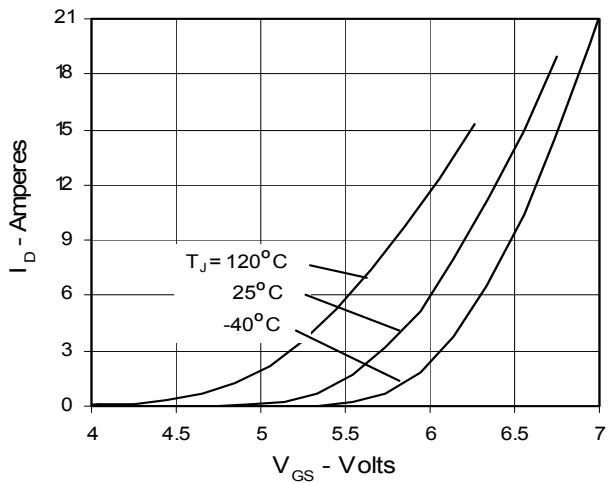
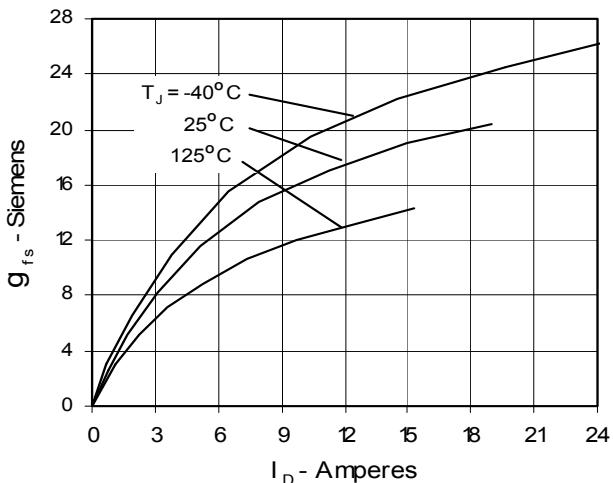
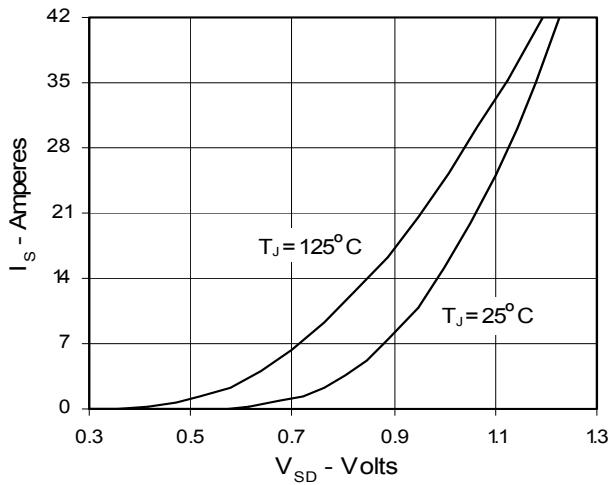
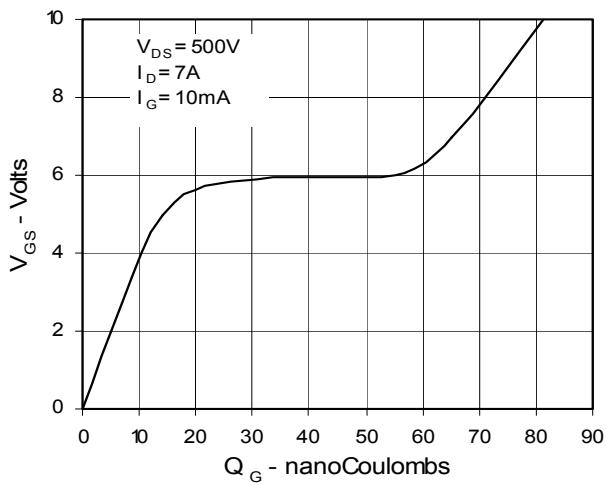
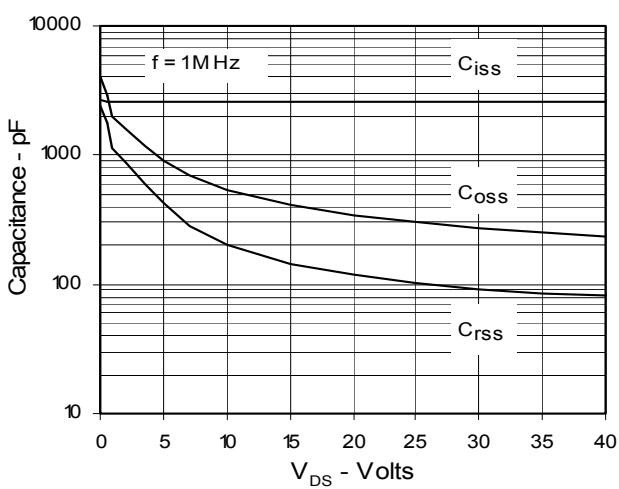


**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_{D25}$  Value vs. Junction Temperature**



**Fig. 6. Drain Current vs. Case Temperature**



**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Source Current vs. Source-To-Drain Voltage**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Maximum Transient Thermal Resistance**
